

Horizons Workforce Development Program

*Strengthening the American Workforce in **Artificial Intelligence, Quantum Science and Engineering, and Advanced Manufacturing***

TechConnect is excited to announce the Horizons Workforce Development Program, taking place during TechConnect World Innovation Conference, March 23-25, 2027, in Boston, MA.

America's future depends on a new generation of talent skilled in **artificial intelligence, quantum technologies, and advanced manufacturing**. These cutting edge emerging technology fields shape how next generation technologies ranging from agriculture, health care, energy, and defense are designed, built, and operated.

For example:

- AI is accelerating innovation and technical solutions to society's biggest challenges.
- Quantum technologies are redesigning computation and navigation.
- Advanced manufacturing is increasing the efficiency and performance of everyday technologies.

By developing skills in these areas, students can directly restore and advance America's science and technology leadership while preparing for high-impact careers across all sectors.

The Horizons Workforce Development Program is open to anyone across the educational spectrum, from community college through graduate school, and will connect students with industry, researchers, and career pathways.

The 2027 program will include:

- Student-industry speed networking
- Career awareness fair
- Career-focused panel discussions
- Technical tutorials
- Student poster sessions
- Student networking sessions
- and more!

Whether you are exploring career options, building professional connections, or showcasing your research, the Horizons Workforce Development Program offers students hands-on opportunities to engage with the technologies shaping the future of America's science and technology innovation.

STUDENTS AND EDUCATORS:

Apply for a travel grant to cover your travel expenses.

Deadline: November 6, 2026

INDUSTRY PARTICIPANTS:

Submit industry participation questionnaire to help us assess interest.

Deadline: November 6, 2026

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